

## LVH200G1201\_Preliminary

## LVH200G1201Z\*\_Preliminary

### Features

- Soft Punch Through IGBT(SPT+ IGBT)
  - Low saturation voltage
  - Positive temperature coefficient
  - Fast Switching
  - High ruggedness
- Free wheeling diodes with fast and soft reverse recovery
- Industrial standard package with copper base plate
- 10us Short circuit rated
- Included gate surge protection function

**SUSPM2**

94.5 X 48.5 X 30 mm

### Application

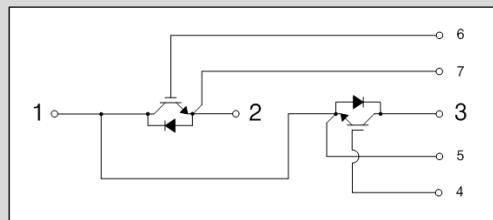
- Welder
- Power Supply
- Industrial Motor Drive

### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Item	Symbol	Condition	Value	Units
IGBT	$V_{CES}$		1200	V
	$V_{GES}$		$\pm 20$	V
	$I_C$	$@T_C = 25^\circ\text{C}$		A
		$@T_C = 80^\circ\text{C}$	200	A
	$I_{CM}$	$@T_C = 25^\circ\text{C}, t_p=1\text{ms}$		A
	$T_{sc}$	$@T_j = 125^\circ\text{C}, V_{CC} = 600\text{V}, V_{GE} = 15\text{V}$	10	us
	$T_j$	Operating Junction Temperature	-40 to + 125	$^\circ\text{C}$
	$P_D$	$@T_C = 25^\circ\text{C}$	1786	W
		$@T_C = 80^\circ\text{C}$	1000	W
Inverse Diode	$V_{RRM}$		1200	V
	$I_F$	$@T_C = 25^\circ\text{C}$		A
		$@T_C = 80^\circ\text{C}$	200	A
	$I_{FRM}$	$@T_C = 25^\circ\text{C}, t_p=1\text{ms}$		A
	$I_{FSM}$	$@T_C = 25^\circ\text{C}, t_p=10\text{ms, Sine}$		A
		$@T_C = 125^\circ\text{C}, t_p=10\text{ms, Sine}$		A
	$T_j$	Operating Junction Temperature	-40 to + 125	$^\circ\text{C}$
	$P_D$	$@T_C = 25^\circ\text{C}$	833	W
		$@T_C = 80^\circ\text{C}$	467	W
Module	$T_{stg}$	Storage Temperature	-40 to + 125	$^\circ\text{C}$
	$V_{iso}$	$@AC 1\text{minute}$	2500	V
	$M_t$	Main Terminal Mounting torque( M6)	2.5 ~ 5.0	Nm
	$M_s$	Heat sink Mounting torque(M6)	3.0 ~ 5.0	Nm
	$W$	Weight	240	g

### Internal Circuit & Pin Description

Pin Number	Pin Name	Pin Description
1	C2E1	Output
2	E2	Negative DC Link Output
3	C1	Positive DC Link Output
4	G1	Gate Input for High-side
5	E1	Emitter Input for High-side
6	G2	Gate Input for Low-side
7	E2	Emitter Input for Low-side



### Electrical Characteristics of IGBT $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
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#### Off Characteristics

$\text{BV}_{\text{CES}}$	C-E Breakdown Voltage	$V_{\text{GE}} = 0\text{V}, I_{\text{C}} = 250\mu\text{A}$	1200	-	-	V
$I_{\text{CES}}$	Collector Cut-Off Current	$V_{\text{CE}} = \text{V}_{\text{CES}}, V_{\text{GE}} = 0\text{V}$	-	-	1.0	mA
$I_{\text{GES}}$	G-E Leakage Current	$V_{\text{GE}} = \text{V}_{\text{GES}}, V_{\text{CE}} = 0\text{V}$	-200	-	200	nA

#### On Characteristics

$V_{\text{GE}(\text{th})}$	G-E Threshold Voltage	$V_{\text{GE}} = V_{\text{CE}}, I_{\text{C}}=200\text{mA}$	-	6.95	-	V
$V_{\text{CE}(\text{sat})}$	Collector to Emitter Saturation Voltage	$I_{\text{C}}=200\text{A}, V_{\text{GE}} = 15\text{V}, T_c=25^\circ\text{C}$	-	2.00	-	V

#### Dynamic Characteristics

$C_{\text{ies}}$	Input Capacitance	$V_{\text{CE}} = 25\text{V}, V_{\text{GE}} = 0\text{V}, f = 1\text{MHz}, T_c=25^\circ\text{C}$	-	-	-	nF
$C_{\text{oes}}$	Output Capacitance		-	-	-	nF
$C_{\text{res}}$	Reverse Transfer Capacitance		-	-	-	nF

#### Switching Characteristics

$t_{\text{d}(\text{on})}$	Turn-On Delay Time	Tc=25°C, RG=5 Ohm L=100 uH, VDC=600V VGE=15V ~ -15V IC=200A	-	90	-	ns
$t_r$	Rise Time		-	65	-	ns
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time		-	490	-	ns
$t_f$	Fall Time		-	80	-	ns
$E_{\text{on}}$	Turn-On Switching Loss		-	15.25	-	mJ
$E_{\text{off}}$	Turn-Off Switching Loss		-	11.25	-	mJ
$E_{\text{ts}}$	Total Switching Loss		-	26.50	-	mJ
$Q_g$	Total Gate Charge		-	-	-	nC
$Q_{\text{ge}}$	Gate-Emitter Charge		-	-	-	nC
$Q_{\text{gc}}$	Gate-Collector Charge		-	-	-	nC

### Electrical Characteristics of Inverse Diode $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	$I_F=200\text{A}, V_{\text{GE}}=0\text{V}$	Test Conditions		Min.	Typ.	Max.	Units
			$T_C = 25^\circ\text{C}$	$T_C = 125^\circ\text{C}$				
$t_{\text{rr}}$	Diode Reverse Recovery Time		$T_C = 25^\circ\text{C}$	-	-	-	ns	
			$T_C = 125^\circ\text{C}$	-	-	-		
$I_{\text{RRM}}$	Diode Peak Reverse Recovery Current		$T_C = 25^\circ\text{C}$	-	-	-	A	
			$T_C = 125^\circ\text{C}$	-	-	-		
$Q_{\text{rr}}$	Diode Reverse Recovery Charge		$T_C = 25^\circ\text{C}$	-	-	-	uC	
			$T_C = 125^\circ\text{C}$	-	-	-		
$E_{\text{rr}}$	Diode Reverse Recovery Energy		$T_C = 25^\circ\text{C}$	-	-	-	mJ	
			$T_C = 125^\circ\text{C}$	-	-	-		

#### Thermal Characteristics

Symbol	Parameter	Min	Typ.	Max.	Units
$R_{\text{th}(\text{J-C})}$	Junction-to-Case (IGBT Part)	-	0.07	-	°C/W
$R_{\text{th}(\text{J-C})D}$	Junction-to-Case (Diode Part)	-	0.15	-	°C/W

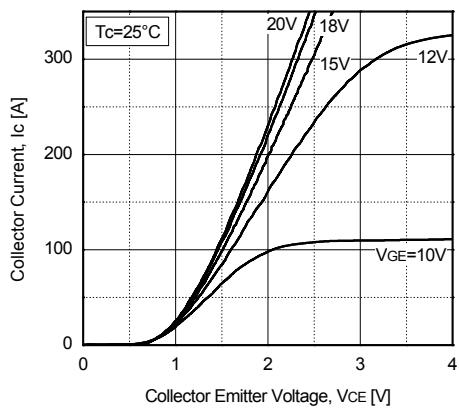


Fig 1. Typical Output Characteristics

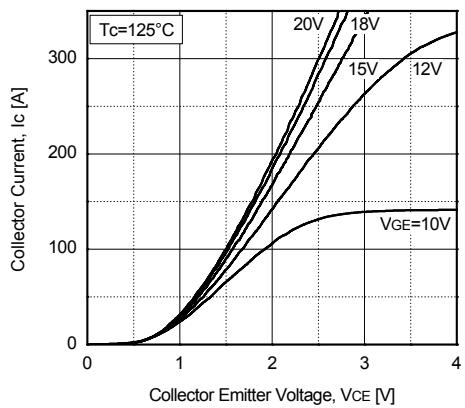


Fig 2. Typical Output Characteristics

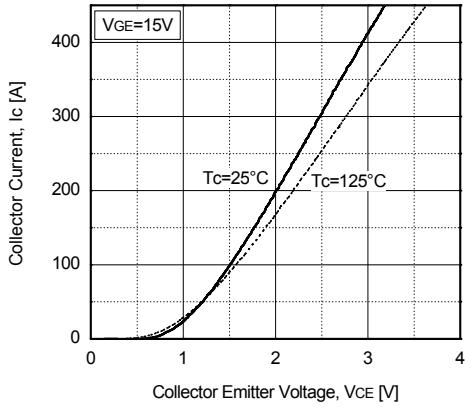


Fig 3. Typical Transfer Characteristics

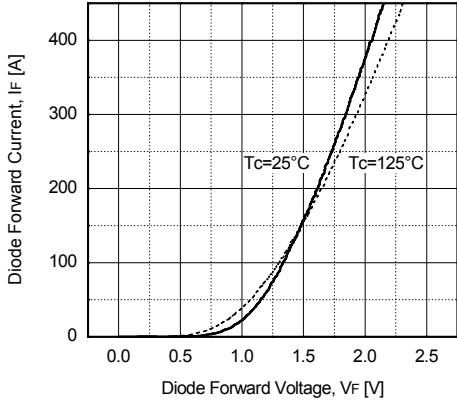


Fig 4. Typical Diode Forward Characteristics

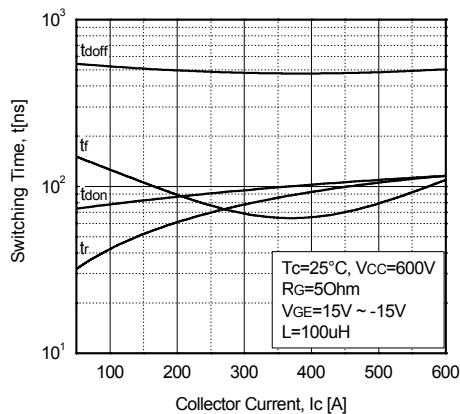


Fig 5. Typical Switching Time vs Collector Current

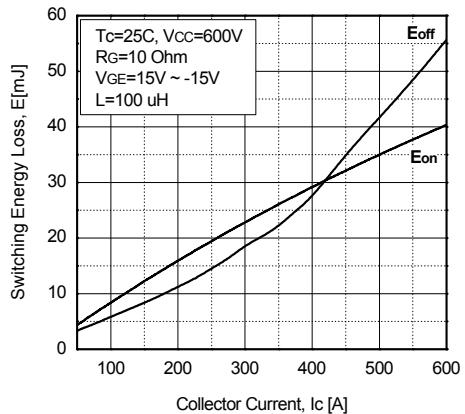


Fig 6. Typical Switching Loss vs Collector Current

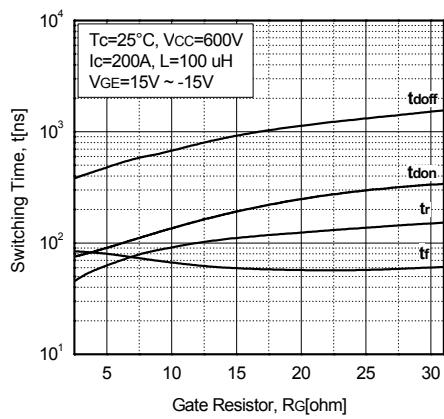


Fig 7. Typical Switching Time vs Gate Resistor

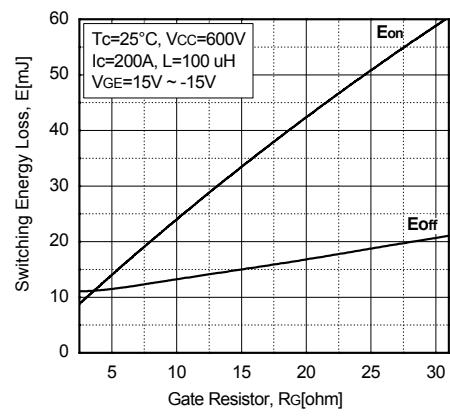


Fig 8. Typical Switching Loss vs Gate Resistor

## Package Dimension (dimensions in mm)

